LISTING OF CLAIMS

This listing of claims provided below will replace all prior versions and listings of claims in the application.

- 1. (Original) A process for producing a poly(methyl methacrylate)-metal cluster composite, which comprises bringing poly(methyl methacrylate) into contact with a heavy metal compound under ultraviolet irradiation.
- 2. (Original) A process for producing a poly(methyl methacrylate)-metal cluster composite, which comprises bringing a poly(methyl methacrylate) basal plate having an ultraviolet-irradiated portion into contact with vapor of a heavy metal compound to form heavy metal nanoparticles on the ultraviolet-irradiated portion.
- 3. (Original) The process for producing a poly(methyl methacrylate)-metal cluster composite according to claim 1 or 2, wherein the heavy metal compound is selected from acetylacetonate complexes of palladium, cobalt or copper.
- 4. (Original) The process for producing a poly(methyl methacrylate)-metal cluster composite according to claim 2, wherein the poly(methyl methacrylate) basal plate is brought into contact with vapor of the heavy metal compound in a non-oxidizing atmosphere.
- 5. (Original) The process for producing a poly(methyl methacrylate)-metal cluster composite according to claim 2, wherein the poly(methyl methacrylate) basal plate is brought

into contact with vapor of the heavy metal compound at a temperature of glass transition temperature of the poly(methyl methacrylate) basal plate or higher.

- 6. (Original) The process for producing a poly(methyl methacrylate)-metal cluster composite according to claim 2, wherein the ultraviolet-irradiated portion is formed in a predetermined pattern.
- 7. (Previously presented) The process for producing a poly(methyl methacrylate)-metal cluster composite according to claim 6, wherein the predetermined pattern is formed by masking.
- 8. (Withdrawn) A patterning material which comprises a poly(methyl methacrylate)-metal cluster composite obtainable by the process according to claim 1 or 2.
- 9. (Original) A method for patterning metal nanoparticles having a predetermined form on a poly(methyl methacrylate) basal plate, which comprises forming a masking portion having a predetermined form on the poly(methyl methacrylate) basal plate having an ultravioletirradiated portion, and then bringing the plate into contact with vapor of a heavy metal compound to form metal nanoparticles on a non-masking portion.